

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT6186606

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
LEI ZHANG	06/28/2019
WEI GAO	06/28/2019
JINGHUA NIU	06/28/2019
WENPENG DAI	06/28/2019
PING AN	06/28/2019
RECEIVING PARTY DATA	
Name:	WUHAN TIANMA MICRO-ELECTRONICS CO., LTD.
Street Address:	8TH LIUFANGYUAN RD, DONGYI INDUSTRIAL PARK
Internal Address:	EAST LAKE HI-TECH DEVELOPMENT ZONE
City:	WUHAN
State/Country:	CHINA
Postal Code:	430205
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16502408
CORRESPONDENCE DATA	
Fax Number:	(704)444-1111
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	6508382000
Email:	Angela.Pham@alston.com
Correspondent Name:	ALSTON & BIRD LLP
Address Line 1:	BANK OF AMERICA PLAZA
Address Line 2:	101 SOUTH TRYON STREET, SUITE 4000
Address Line 4:	CHARLOTTE, NORTH CAROLINA 28280
ATTORNEY DOCKET NUMBER:	061706-533848 (046200US)
NAME OF SUBMITTER:	ARDESHIR TABIBI
SIGNATURE:	/Ardeshir Tabibi/
DATE SIGNED:	07/06/2020

Total Attachments: 2

source=533848US Executed Assignment#page1.tif

source=533848US Executed Assignment#page2.tif

ASSIGNMENT

WHEREAS, we, ZHANG,Lei of Shanghai, China, GAO,Wei of Shanghai, China, NIU,Jinghua of Shanghai, China, DAI,Wenpeng of Shanghai, China, AN,Ping of Shanghai, China, ("Assignor"), are the inventors of an invention entitled "ORGANIC COMPOUND, DISPLAY PANEL AND DISPLAY DEVICE" that is the subject matter of: (check all that apply)

- a U.S. application for Letters Patent which claims the priority of the Chinese Patent Application No. 201811581250.3 filed on December 24, 2018.
- an application made under the Patent Cooperation Treaty which is identifiable at WIPO by Application No. PCT/___ filed on ___.
- an application for Letters Patent which is identifiable in the Patent Office of ___ the U.S. by Application No. _____ filed on _____.

WHEREAS, Wuhan TianMa Micro-electronics CO.,LTD., a corporation organized and existing under the laws of China ("Assignee"), and having offices at 8th Luofangyuan Rd, Dongyi Industrial park, East Lake Hi-tech Development Zone, Wuhan, China is desirous of acquiring the entire right, title and interest in and to the invention, the applications, and any and all Letters Patent or similar foreign or domestic legal protection:

- in the United States
- in all other countries or jurisdictions;

"NOW THEREFORE, for good and valuable consideration, the receipt and adequacy of which is hereby acknowledged,

- a) we agree to transfer, and
b) we do hereby transfer,

to Assignee, its successors and assigns, effective as of December 24, 2018 *nunc pro tunc*, our entire right, title and interest in the above named countries and jurisdictions in and to the following including the right to sue for past infringement: the invention, the above-identified applications, all applications from which any of the above-identified applications claim priority, corresponding U.S. and non-U.S. applications, any continuation, division, renewal, or substitute for the applications, all Letters Patent, any reissue, re-examination, or similar legal protection issuing related to the Letters Patent, and all rights and benefits under any applicable treaty or convention, and I/we authorize the Director of the United States Patent and Trademark Office or foreign equivalent to issue the Letters Patent or similar legal protection to the Assignee."

We authorize the U.S. Attorneys handling this matter in the U.S. and the Assignee, its successors and assigns, to insert in this instrument the filing date(s) and application numbers when ascertained. We further authorize the Assignee, its successors and assigns, or anyone it may properly designate, to apply for Letters Patent or similar legal protection, in its own name if desired, in the above named countries and jurisdictions and appoint Assignee the common representative in the above-identified international application and any international application for the invention.

We represent to the Assignee, its successors and assigns, that we shall not execute any writing or do any act whatsoever conflicting with this Assignment. We, our executors or administrators, will at any time upon request, without additional consideration, but at the expense of the Assignee, its successors and assigns, execute and deliver to Assignee or its legal representatives such additional writings and do such additional acts as the Assignee, its successors and assigns, may deem desirable to perfect its enjoyment of this grant, and render all assistance in making application for and obtaining, maintaining, and enforcing the Letters Patent or similar legal protection on the invention in any and all countries and jurisdictions, including without limitation providing testimony in any related interference, litigation or proceeding. To the extent that we, our executors or administrators are unable or unavailable to execute and deliver to Assignee or its legal representatives such additional writings and do such additional acts as Assignee, its successors and assigns may deem desirable to perfect its enjoyment of this grant, and render all assistance in making application for and obtaining, maintaining, and enforcing the Letters Patent or similar legal protection on the invention in any and all countries and jurisdictions, we, our executors or administrators hereby authorize Assignee, its successors and assigns to act on our behalf.

If any provision(s) of this Assignment are held unenforceable or in conflict with the law of any jurisdiction, the validity of the remaining provisions will not be affected by such holding and the part held unenforceable in or in conflict with the law of one jurisdiction will remain in effect for other jurisdictions until held unenforceable or in conflict with the law of that jurisdiction.

ZHANG, Lei

ZHANG, Lei
(Inventor / Assignor)

2019. 6. 28
Date

GAO, Wei

GAO, Wei
(Inventor / Assignor)

2019. 6. 28
Date

NIU, Jinghua

NIU, Jinghua
(Inventor / Assignor)

2019. 6. 28
Date

DAI, Wenpeng

DAI, Wenpeng
(Inventor / Assignor)

2019. 6. 28
Date

AN, Ping

AN, Ping
(Inventor / Assignor)

2019. 06. 28
Date